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Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                    |                                 |                       |  |  |  |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω) MAX.       | I <sub>D</sub> (A) <sup>d</sup> | Q <sub>g</sub> (TYP.) |  |  |  |
|                     | 0.0062 at V <sub>GS</sub> = -10 V  | -25.3                           |                       |  |  |  |
| -30                 | 0.0074 at V <sub>GS</sub> = -6 V   | -23.2                           | 54 nC                 |  |  |  |
|                     | 0.0092 at V <sub>GS</sub> = -4.5 V | -20.8                           |                       |  |  |  |



#### **FEATURES**

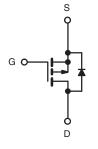
- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization:
   For definitions of compliance please see www.vishav.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

## **APPLICATIONS**

- Adaptor switch, load switch
- Power management
- Notebook computers



P-Channel MOSFET

# **Ordering Information:**

Si4143DY-T1-GE3 (lead (Pb)-free and halogen-free)

| PARAMETER  | SYMBOL                            | LIMIT           | UNIT                  |     |  |
|--|-----------------------------------|-----------------|-----------------------|-----|--|
| Drain-Source Voltage                               | V <sub>DS</sub>                   | -30             | V                     |     |  |
| Gate-Source Voltage                                | V <sub>GS</sub>                   | ± 25            | <b>─</b>              |     |  |
|  | T <sub>C</sub> = 25 °C            |                 | -25.3                 |     |  |
| Continuous Dunin Comment (T. 150 °C)               | T <sub>C</sub> = 70 °C            | 1 , $\square$   | -20.2                 |     |  |
| Continuous Drain Current (T <sub>J</sub> = 150 °C) | T <sub>A</sub> = 25 °C            | I <sub>D</sub>  | -17.7 <sup>a, b</sup> |     |  |
|  | T <sub>A</sub> = 70 °C            |                 | -14.1 <sup>a, b</sup> |     |  |
| Pulsed Drain Current (t = 300 μs)                  | I <sub>DM</sub>                   | -70             | Α                     |     |  |
| Continuous Courses Ducin Diede Coursest            | T <sub>C</sub> = 25 °C            |                 | -5                    |     |  |
| Continuous Source-Drain Diode Current              | T <sub>A</sub> = 25 °C            | I <sub>S</sub>  | -2.4 <sup>a, b</sup>  |     |  |
| Avalanche Current                                  | L = 0.1 mH                        | I <sub>AS</sub> | -30                   |     |  |
| Single Pulse Avalanche Energy                      | E <sub>AS</sub>                   | 45              | mJ                    |     |  |
|  | T <sub>C</sub> = 25 °C            |                 | 6                     |     |  |
| Marriagona Darrag Diagia etia e                    | T <sub>C</sub> = 70 °C            |                 | 3.8                   | 10/ |  |
| Maximum Power Dissipation                          | T <sub>A</sub> = 25 °C            | P <sub>D</sub>  | 2.9 <sup>a, b</sup>   | W   |  |
|  | T <sub>A</sub> = 70 °C            |                 | 1.9 <sup>a, b</sup>   |     |  |
| Operating Junction and Storage Temperature Ra      | T <sub>J</sub> , T <sub>stq</sub> | -55 to 150      | °C                    |     |  |

| THERMAL RESISTANCE RATINGS       |              |            |         |         |      |  |  |
|----------------------------------|--------------|------------|---------|---------|------|--|--|
| PARAMETER                        | SYMBOL       | TYPICAL    | MAXIMUM | UNIT    |      |  |  |
| Maximum Junction-to-Ambient a, c | t ≤ 10 s     | $R_{thJA}$ | 36      | 43 °C/W |      |  |  |
| Maximum Junction-to-Foot         | Steady State | $R_{thJF}$ | 16      | 21      | C/VV |  |  |

### Notes

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 84 °C/W.
- d. Based on  $T_C = 25$  °C.



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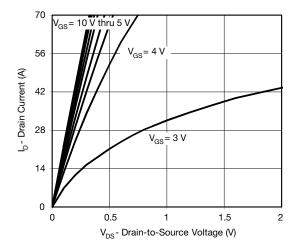
| PARAMETER                                   | SYMBOL                  | TEST CONDITIONS   | MIN. | TYP.   | MAX.   | UNIT  |  |
|---|-------------------------|---|------|--------|--------|-------|--|
| Static                                      |                         |   |      | •      |        |       |  |
| Drain-Source Breakdown Voltage              | $V_{DS}$                | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$                                | -30  | -      | -      | V     |  |
| V <sub>DS</sub> Temperature Coefficient     | $\Delta V_{DS}/T_{J}$   |   | -    | -23    | -      | 14/00 |  |
| V <sub>GS(th)</sub> Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = -250 μA  | -    | 4.9    | -      | mV/°C |  |
| Gate-Source Threshold Voltage               | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$   | -1   | -      | -2.5   | V     |  |
| Gate-Source Leakage                         | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$                             | -    | -      | ± 100  | nA    |  |
| Zon Oale Vellere Build Oansel               |                         | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$                                |      |        | -1     |       |  |
| Zero Gate Voltage Drain Current             | I <sub>DSS</sub>        | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$   | -    | -      | -5     | μA    |  |
| On-State Drain Current <sup>a</sup>         | I <sub>D(on)</sub>      | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$                            | -30  | -      | -      | Α     |  |
|   | , ,                     | $V_{GS} = -10 \text{ V}, I_D = -12 \text{ A}$                                 | -    | 0.0051 | 0.0062 | Ω     |  |
| Drain-Source On-State Resistance a          | R <sub>DS(on)</sub>     | $V_{GS} = -6 \text{ V}, I_D = -8 \text{ A}$                                   | -    | 0.0061 | 0.0074 |       |  |
|   | , ,                     | $V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$                                 | -    | 0.0076 | 0.0092 |       |  |
| Forward Transconductance <sup>a</sup>       | 9 <sub>fs</sub>         | $V_{DS} = -10 \text{ V}, I_D = -15 \text{ A}$                                 | -    | 64     | -      | S     |  |
| Dynamic <sup>b</sup>                        |                         |   |      | •      |        |       |  |
| Input Capacitance                           | C <sub>iss</sub>        |   | -    | 6630   | -      |       |  |
| Output Capacitance                          | C <sub>oss</sub>        | V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz                     | -    | 750    | -      | pF    |  |
| Reverse Transfer Capacitance                | C <sub>rss</sub>        |   | -    | 710    | -      |       |  |
| T. 10 1 01                                  | 0                       | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -18 \text{ A}$         | -    | 111    | 167    | nC    |  |
| Total Gate Charge                           | Q <sub>g</sub>          |   | -    | 54     | 81     |       |  |
| Gate-Source Charge                          | Q <sub>gs</sub>         | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -18 \text{ A}$      | -    | 19.5   | -      |       |  |
| Gate-Drain Charge                           | Q <sub>gd</sub>         |   | -    | 15.5   | -      |       |  |
| Gate Resistance                             | $R_g$                   | f = 1 MHz   | 0.5  | 2.3    | 4.6    | Ω     |  |
| Turn-On Delay Time                          | t <sub>d(on)</sub>      |   | -    | 18     | 27     |       |  |
| Rise Time                                   | t <sub>r</sub>          | $V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$                                  | -    | 8      | 16     |       |  |
| Turn-Off Delay Time                         | t <sub>d(off)</sub>     | $I_D \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$            | -    | 71     | 107    |       |  |
| Fall Time                                   | t <sub>f</sub>          |   | -    | 15     | 23     |       |  |
| Turn-On Delay Time                          | t <sub>d(on)</sub>      |   | -    | 59     | 89     | ns    |  |
| Rise Time                                   | t <sub>r</sub>          | $V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$                                  | -    | 60     | 90     | ]     |  |
| Turn-Off Delay Time                         | t <sub>d(off)</sub>     | $I_D \cong -10 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$           | -    | 56     | 84     |       |  |
| Fall Time                                   | t <sub>f</sub>          |   | -    | 29     | 44     |       |  |
| Drain-Source Body Diode Characterist        | cs                      |   |      |        |        |       |  |
| Continuous Source-Drain Diode Current       | Is                      | T <sub>C</sub> = 25 °C  | -    | -      | -5     | ^     |  |
| Pulse Diode Forward Current                 | I <sub>SM</sub>         |   | -    | -      | -70    | A     |  |
| Body Diode Voltage                          | $V_{SD}$                | I <sub>S</sub> = -10 A, V <sub>GS</sub> = 0 V                                 | -    | -0.78  | -1.2   | V     |  |
| Body Diode Reverse Recovery Time            | t <sub>rr</sub>         |   | -    | 42     | 63     | ns    |  |
| Body Diode Reverse Recovery Charge          | covery Charge Orr       |   | -    | 37     | 56     | nC    |  |
| Reverse Recovery Fall Time                  | ta                      | $I_F = -10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °C$ | -    | 17     | -      |       |  |
| Reverse Recovery Rise Time                  | t <sub>b</sub>          |   | -    | 25     | -      | ns    |  |

## Notes

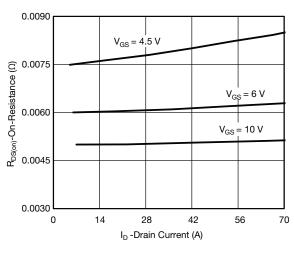
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

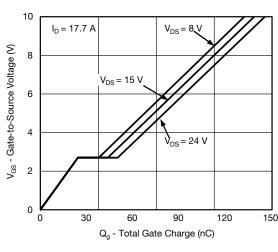




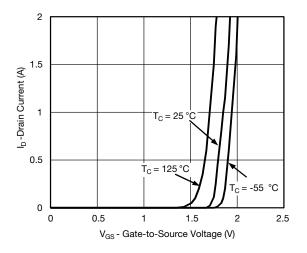
#### **Output Characteristics**



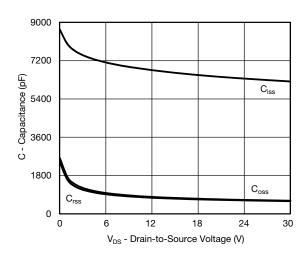
#### On-Resistance vs. Drain Current



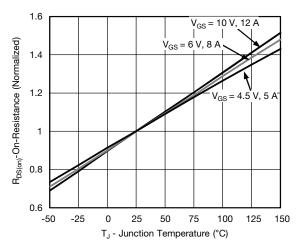
**Gate Charge** 



#### **Transfer Characteristics**

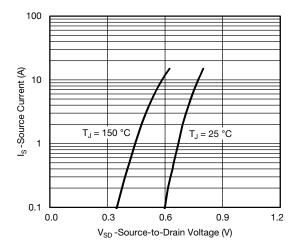


#### Capacitance

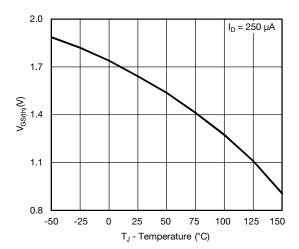


On-Resistance vs. Junction Temperature

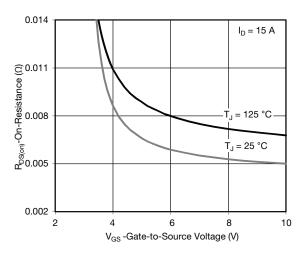




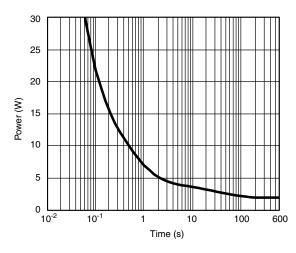
#### Source-Drain Diode Forward Voltage



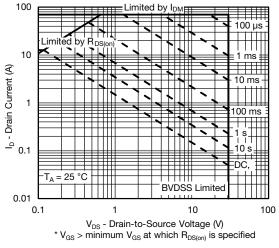
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

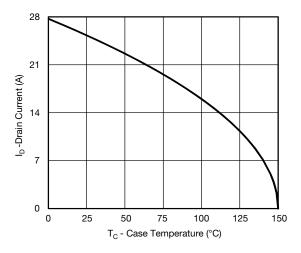


Single Pulse Power, Junction-to-Ambient

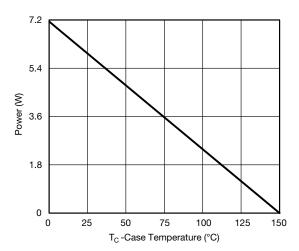


Safe Operating Area

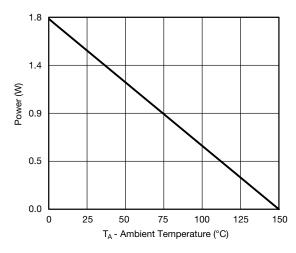




#### **Current Derating\***



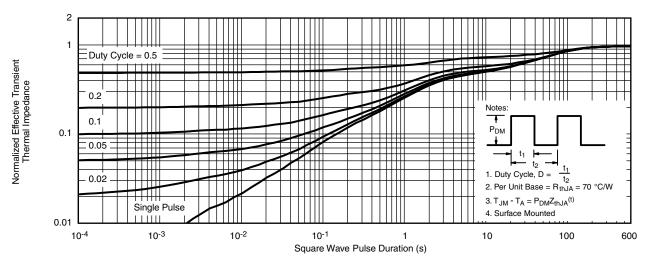




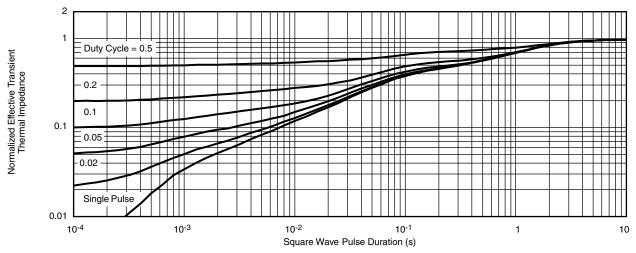
Power Derating, Junction-to-Ambient

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J \text{ (max.)}} = 150 \,^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg263242">www.vishay.com/ppg263242</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







|                                | MILLIM | IETERS | INCHES    |       |  |  |
|--------------------------------|--------|--------|-----------|-------|--|--|
| DIM                            | Min    | Max    | Min       | Max   |  |  |
| Α                              | 1.35   | 1.75   | 0.053     | 0.069 |  |  |
| A <sub>1</sub>                 | 0.10   | 0.20   | 0.004     | 0.008 |  |  |
| В                              | 0.35   | 0.51   | 0.014     | 0.020 |  |  |
| С                              | 0.19   | 0.25   | 0.0075    | 0.010 |  |  |
| D                              | 4.80   | 5.00   | 0.189     | 0.196 |  |  |
| Е                              | 3.80   | 4.00   | 0.150     | 0.157 |  |  |
| е                              | 1.27   | BSC    | 0.050 BSC |       |  |  |
| Н                              | 5.80   | 6.20   | 0.228     | 0.244 |  |  |
| h                              | 0.25   | 0.50   | 0.010     | 0.020 |  |  |
| L                              | 0.50   | 0.93   | 0.020     | 0.037 |  |  |
| q                              | 0°     | 8°     | 0°        | 8°    |  |  |
| S                              | 0.44   | 0.64   | 0.018     | 0.026 |  |  |
| ECN: C-06527-Rev. I. 11-Sep-06 |        |        |           |       |  |  |

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# LON NOTE



# **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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